Popular Programs
- Aerospace Engineering
- Materials Science and Engineering
- Machine Design Manufacture and Automation
- Civil Engineering
- Electronics and Information Engineering
- Electrical Engineering and Automation
- Computer Science and Technology
- Business Administration
- Biotechnology

Postgraduate Program
- Flight Vehicle Design
- Aeronautical and Astronautical Science and Technology
- Materials Science
- Mechanical Engineering
- Information and Communication Engineering
- Civil engineering
- Electronics Science and Technology
- Computer Science and Technology
- Management Science and Engineering
- Mathematics
- Software Engineering

Outstanding Visiting Student Scholarship
NPU will provide Scholarship for the students from partner universities or the Top 200 universities listed in world ranking.

Scholarship Coverage
- Tuition
- Medical Insurance
- Dormitory Housing
- Living allowance

Application Deadline
- 15th April (Autumn semester)
- 15th December (Spring semester)

How to apply
- **Step 1**: Nomination (for partner universities only)
  - The nomination deadline for partner universities will be determined by NPU.
- **Step 2**: Online application
  - Choose "Exchange program": Fill in the application form online and click "submit"
- **Step 3**: Review
  - Applicants can track the admission progress via portal and email.
- **Step 4**: Scholarship Interview (apply)

Required Documents
- 1. Information page of passport (the validity of passport should be more than 6 months).
- 2. Notarized highest diploma and study certificate officially issued by current university.
- 3. Academic transcripts.
- 4. Language proficiency certificate (IELTS 6.0 or TOEFL 80 or Duolingo 115. Not required for native speakers).
- 5. Acceptance letter from a NPU professor (only required for individual applicants).
- 6. Physical examination form.
  - *All the documents uploaded should be clear.

Contacts
- Office: Admission office, International College, NPU
  - Office: LI Mengchen (Daisy)
  - Tel: +86-29-88494381
  - E-mail: extljs@npu.edu.cn
  - Website: https://study.npu.edu.cn/index.htm
  - Application Portal: https://admission.npu.edu.cn/
  - Address: Room 715/717, Yish Building, International College, Northwestern Polytechnical University, 127 Youyi West, Xian District, Xi’an, Shaanxi, China, 710072

STRIVE FOR EXCELLENCE

Northwestern Polytechnical University Exchange Program

峥嵘岁月 创新发展
Northwestern Polytechnical University: A World-Class University
Looking into the Future

Located in the historical and ancient city of Xi’an, Northwestern Polytechnical University (NPU) ranks as a Category A university, as it evolves rapidly with state-of-the-art innovative technologies.

Northwestern Polytechnical University:
- Adhering to the school motto of “Loyalty, Integrity, Courag, Perseverance”, NPU strives to be an open interdisciplinary research university. The core mission of the Northwestern Polytechnical University is to achieve excellence in talent training, multidisciplinary researches and public social services.
- Today’s university diversifies its resources across time and space, and its influence is spread out worldwide.

Lab Research & Internship

- Big data is the “New oil of the future”
- Data is no longer a “by-product” of social production, but a raw material that can be processed twice or even many times, from which greater value can be explored, and it becomes the means of production.
- If you looking to start, learn Map Reduce, Data Mining, Python. Join NPU!

Northwestern Polytechnical University World Rankings

- ARWU World Ranking: #151-200
- U.S. News World Ranking: #333
- QS Five-Star University
- THE World Ranking: #301-350
- Aerospace Engineering World Ranking: #2
- Mechanical Engineering: #6
- Electrical & Electronic Engineering: #13
- Artificial Intelligence: #14

Exchange Options

- Credits Programs (1 Semester or 1 Academic Year)
- Lab Research & Internship (At least 3 months)
- 20 National Key Labs or Centers
- Chinese Language Program (1 Semester or 1 Academic Year)

Flexible Electronics (IFE)

IFE aims flexible electronics, a highly cross-integrated and disruptive discipline form as the research core, and takes the key scientific problems and technical difficulties in flexible photoelectric materials, semiconductor properties, device physical mechanism, device process and integration as the research objects.

The experiments were implemented to investigate the cellular mechanism of space bone loss, delineated the roles of OGP-1 gene silence and application of 3-hydroxybutyrate in resisting microgravity-induced bone formation suppression, and explore the changes on the proliferation and differentiation of mouse (human) embryonic stem cell, PSC cells, liver stem cells, human mesenchymal stem cell under microgravity environment during space flight.